



**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

Applicant: Damion T. Searls et al.

Title: A SURFACE MOUNT SOLDER METHOD AND APPARATUS FOR DECOUPLING  
CAPACITANCE AND PROCESS OF MAKING

Docket No.: 884.766US2

Filed: February 9, 2004

Examiner: Scott R. Wilson

Customer No.: 21186

Serial No.: 10/774,955

Due Date: October 3, 2006

Group Art Unit: 2826

Confirmation No.: 4225

Commissioner for Patents

Attn: MAIL STOP ISSUE FEE

P.O. Box 1450

Alexandria, VA 22313-1450

**Notice of Allowance Date:**

July 3, 2006

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- ☒ Communication Concerning Related Application(s) (1 pg.)

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SCHWEGMAN, LUNDBERG, WOESSNER & KLUTH, P.A.

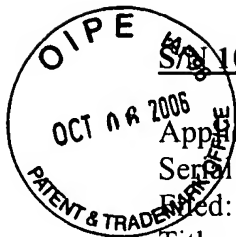
Customer Number: 21186

By Ann M. McCrackin  
Ann M. McCrackin  
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Chris Hammond  
Name

Chris Hammond  
Signature



Serial No. 10/774,955

PATENT

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Title: A SURFACE MOUNT SOLDER METHOD AND APPARATUS FOR  
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**COMMUNICATION CONCERNING RELATED APPLICATION(S)**

**MS Issue Fee**

Commissioner for Patents

P.O. Box 1450

Alexandria, VA 22313-1450

Applicants would like to bring to the Examiner's attention the following related application(s) in the above-identified patent application:

| <u>Serial/Patent No.</u> | <u>Filing Date/Issue Date</u> | <u>Attorney Docket</u> | <u>Title</u>  |
|--------------------------|-------------------------------|------------------------|---|
| 10152524                 | May 21, 2002                  | 884.766US1             | A SURFACE MOUNT SOLDER  |
| 6713871                  | March 30, 2004                |                        | METHOD AND APPARATUS FOR<br>DECOUPLING CAPACITANCE AND<br>PROCESS OF MAKING |

Continuations and divisionals may be later filed on the cases listed above, or cited to the Examiner in any previous Communication Concerning Related Applications. Applicants request that the Examiner review all continuations and divisionals of the above-listed or previously-cited patent applications before allowing the claims of the present patent application.

Respectfully submitted,  
DAMION T. SEARLS ET AL.  
By their Representatives,  
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Date Oct. 3, 2006 By Ann M. McCrackin  
Ann M. McCrackin  
Reg. No. 42,858

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